FP0505R

High frequency, high current power inductors



Description

- · High current carrying capacity
- Low core loss
- 5.0 x 5.0mm footprint surface mount package in an 4.8mm height
- Ferrite core material
- · Halogen free, lead free, RoHS compliant

Applications

- Servers
- Multi-phase and Vcore regulators
- Voltage Regulator Modules (VRMs)
- · Desktop VRMs and EVRDs
- · Data networking and storage systems
- Graphics cards and battery power systems
- · Point-of-Load modules

Environmental Data

- Storage temperature range (Component): -40°C to +125°C
- Operating temperature range: -40°C to +125°C (ambient + self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant









Product Specifications

Part Number ⁸	OCL ¹ (nH) ±10%	FLL ² (nH) minimum	I _{rms} ³ (amps)	l _{sat} 1 ⁴ (amps)	I _{sat} 2 ⁵ (amps)	I _{sat} 3 ⁶ (amps)	DCR (mΩ) ±25% @ 20°C	K-factor ⁷
R1 Version	,	,	'		'	,	'	
FP0505R1-R100-R	100	68	30	34	26	24	0.38	1279

- 1. Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.1Vrms, 0.0Adc, @ +25°C
- 2. Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1Vrms, @ I_{sat'} @ +25°C
- 3.1_{max}: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.
- 4. I_{sat}1: Peak current for approximately 20% rolloff @ +25°C
- 5. I_{sat}2: Peak current for approximately 20% rolloff @ +100°C
- 6. I_{sat}3: Peak current for approximately 20% rolloff @ +125°C
- 7. K-factor: Used to determine $B_{p,p}$ for core loss (see graph). $Bp-p = K * L * \Delta I * 10^3 B_{p-p}$: (Gauss),
- K: (K-factor from table), L: (Inductance in nH), Δ I (Peak to peak ripple current in Amps).
- 8. Part Number Definition: FP0505Rx-Rxxx-R

FP0505R = Product code and size

x= Version indicator

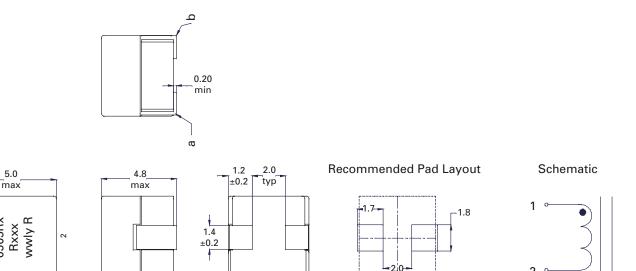
Rxxx= inductance value in μH , R= decimal point ,

-R suffix = RoHS compliant

Dimensions (mm)

5.0

max



Part marking: 0505Rx (x = Version Indicator), Rxxx = Inductance value in uH (R= decimal point) wwly = date code, R = revision level

Tolerances are ±0.15 millimeters unless stated otherwise

All soldering surfaces to be coplanar within 0.1 millimeters

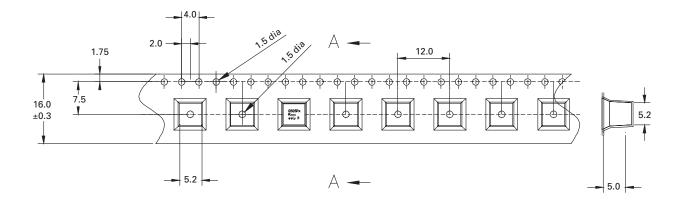
PCB tolerances are ±0.1 millimeters unless stated otherwise

DCR measured from point "a" to point "b"

Do not route traces or vias underneath the inductor

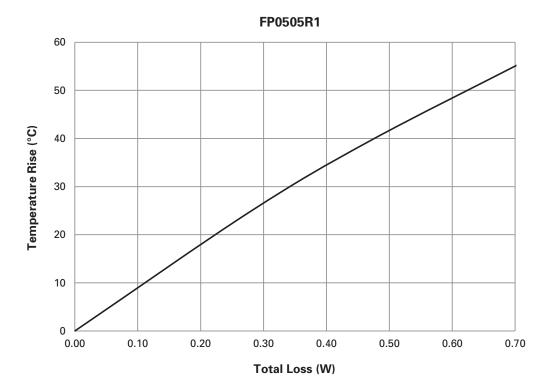
Packaging information (mm)

Supplied in tape and reel packaging, 1,000 parts per 13" diameter reel

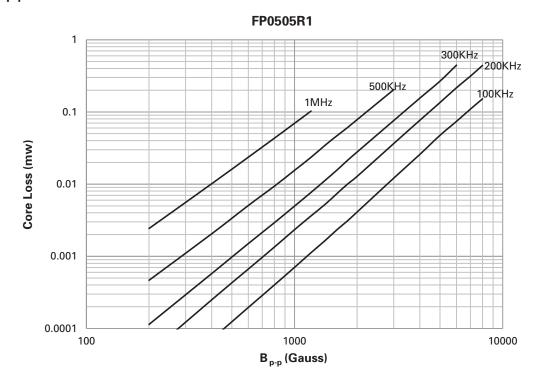


User Direction of feed -

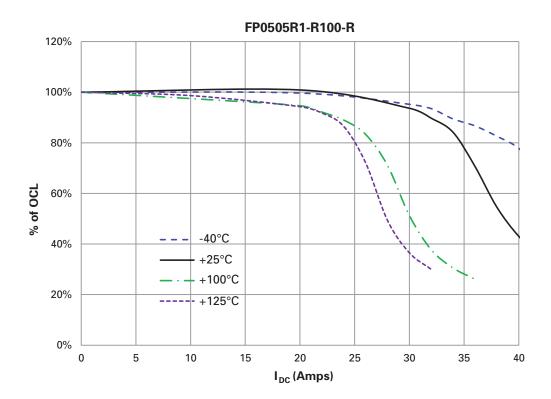
Temperature rise vs. total loss



Core loss vs. B_{p-p}



Inductance characteristics



Solder reflow profile

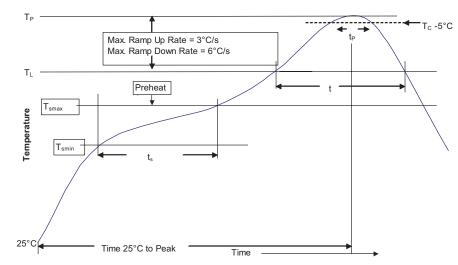


Table 1 - Standard SnPb Solder (T_C)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T_C)

Package Thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak • Temperature min. (T _{smin})	100°C		
Temperature max. (T _{smax})	150°C	200°C	
• Time (T _{smin} to T _{smax}) (t _s)	60-120 Seconds	60-120 Seconds	
Average ramp up rate T_{Smax} to T_{p}	3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL) Time at liquidous (tL)	183°C 60-150 Seconds	217°C 60-150 Seconds	
Peak package body temperature (Tp)*	Table 1	Table 2	
Time (t _p)** within 5 °C of the specified classification temperature (T _c)	20 Seconds**	30 Seconds**	
Average ramp-down rate (T _p to T _{smax})	6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.	

 $^{^{*}}$ Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

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